TOSHIBA LED Lamp InGaAlP Orange Light Emission

TLOH156P

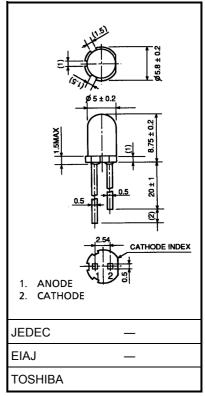
Panel Circuit Indicator

Unit: mm

- 5mm diameter(T1-3 / 4)
- InGaAlP orange LED
- All plastic mold type.
- Colorless clear lens
- Low drive current, high intensity orange light emission Recommended forward current: IF = 1~20mA(DC)
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Fast response time, capable of pulse operation.
- · High power luminous intensity
- Without stand-offs
- Applications: Suitable for outdoor message signboard, safety equipment, automotive use.

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Forward current (DC)	I _F	50	mA	
Reverse voltage	V_{R}	4	٧	
Power dissipation	P _D	125	mW	
Operating temperature range	T _{opr}	-30~85	°C	
Storage temperature range	T _{stg}	-40~120	°C	



Weight: 0.31 g

Electrical And Optical Characteristics (Ta = 25°C)

Cha	aracteristic	Symbol	Test Condition	Mi	п Тур.	Max	Unit
Forward voltage	9	V _F	I _F =20mA	_	2.1	2.5	V
Reverse curren	t	I _R	V _R =4V	_		50	μA
Luminous intensity	TLOH156P	Ι _V	I _E =20mA (No	47	5 1500	_	mcd
	TLOH156P(ST)		11F-2011IA (140	85	0 —	4140	
Peak emission wavelength		λ _p	I _F =20mA	_	612	_	nm
Spectral line half width		Δλ	I _F =20mA	_	15	_	nm
Dominant wavelength		λ _d	I _F =20mA	_	605	_	nm

 $(Note): Lamps \ are \ classified \ into \ the \ following \ ranks \ according \ to \ their \ luminous \ intensity.$

Measurement tolerance for each limit is ±15%.

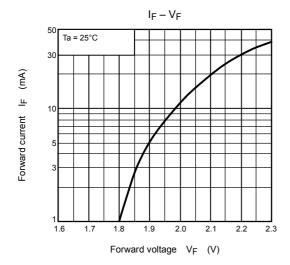
R: 560-1120mcd, S: 1000-2000mcd, T: 1800-3600mcd.

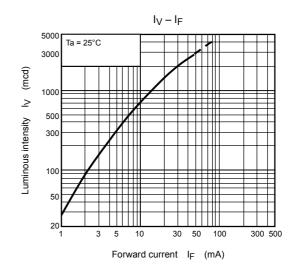
Precaution

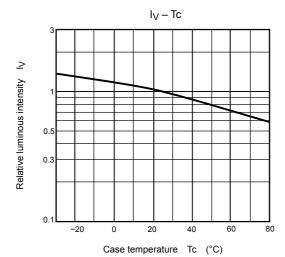
Please be careful of the followings

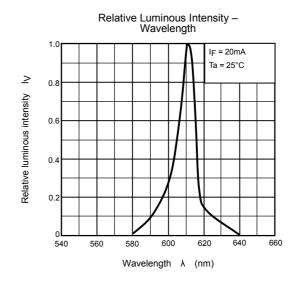
- \bullet Soldering temperature: 260°C max Soldering time: 3s max (Soldering portion of lead: Up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

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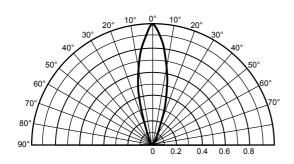


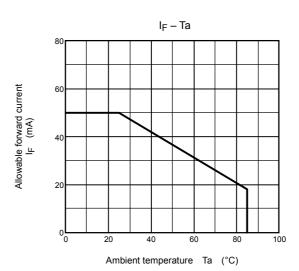




Radiation Pattern

Ta = 25°C





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